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11/19/01

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10021173	FILING DATE 12/19/2001	CLASS 257	SUBCLASS 509	GAU 261 284	EXAMINER <i>Handwritten signature</i>
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****CONTINUING DATA VERIFIED:**

**** FOREIGN APPLICATIONS VERIFIED:**
JAPAN 2001-002371 01/10/2001

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	ATTORNEY DOCKET NO H-1020
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's initials		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	

TITLE : Semiconductor device and a method of manufacturing the same

U.S. DEPT. OF COMM. PAT. & TM. PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
ISSUE FEE		Total Claims Print Claim for 0.0	
Amount Due	Date Paid	DRAWING Sheets Drwg. Figs. Drwg. Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Assistant Examiner Primary Examiner Application Examiner	
<input type="checkbox"/> PREPARED FOR ISSUE		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

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